

Appl. No. 10/519,765
Amdt. Dated July 23, 2007
Reply to Office action of June 1, 2006

AMENDMENT TO THE TITLE:

Please amend the title of the invention to:

**MODULAR BOARD DEVICE, HIGH FREQUENCY MODULE, AND
METHOD FOR PRODUCING THEM OF MANUFACTURING SAME**

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AMENDMENT TO THE SPECIFICATION:

In page 1, after the Title and before the Technical Field of the Invention,
please insert:

"This application claims priority to Japanese Patent Application No. JP2002-195022, filed July 3, 2002, which is incorporated herein by reference."